SHROUDED AND EJECTOR IDC HEADER

(1.27 mm) .050" PITCH • SHF/ESHF/EHF/ECF SERIES

SHF/ESHF

Mates:

FFSD, FFTP (SHF)

EHF

Mates:

FFSD*, FFTP

*Important Note:

EHF will not mate to FFSD with strain relief (-SR option), see ESHF series.

SPECIFICATIONS

Insulator Material: Black Liquid Crystal Polymer **Terminal Material:** Phosphor Bronze Plating:

Sn or Au over 50 µ" (1.27 µm) Ni Operating Temp Range: -55 °C to +125 °C

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max

SERIES

SHF

Mates with

FFSD without

Strain Relief

ESHF

= Mates with

FFSD with

Strain Relief

-TH



04, 05, 06,

08, 10, 11,

12, 13, 15,

17, 20, 25

(Standard sizes)



PLATING OPTION

= 10 µ" (0.25 µm)

Gold on

post, Matte

Tin

on tail



TYPE STRIP

SHE

ESHF

OPTION

OTHER OPTION

-TH = Throughhole

-RA = Right-angle

-SM = Surface Mount

Α

No. of pins x

(1.27) .050 + (6.35) .250

No. of pins x

(1.27) .050 + (10.16) .400

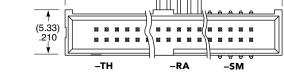
-LC = Locking Clip (Not available with -RA) (Manual placement required)

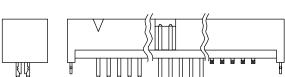
-K = (6.50 mm) .256" DIA Polyimide Film Pick& Place Pad (-SM only)

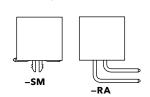
-TR

= Tape & Reel

-FRFull Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks)







NO. PINS **PER ROW**



PLATING OPTION



TAIL **OPTION**

Leave blank for

Through-hole

version

-SM

= Surface Mount

-RA = Right-angle

OTHER OPTION

-"XX"

= Polarized Position

(-RA not available)

-LC

= Locking Clip

(–SM only) (Manual placement

required)

-K = (7.50 mm) .295" DIA

Polyimide Film

Pick & Place Pad

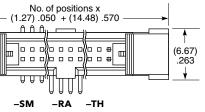
EJECTOR HEADER CAP (8.71) .343 (9.70) No. of positions x (1.27) .050 → + (18.16) .715 NO. PINS PER ROW 05, 08, 10,

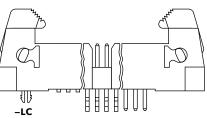
13, 17, 20, 25









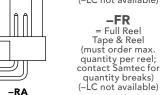


= Gold flash on post,





-P = Pick & Place Pad (–SM only) = Tape & Reel (-LC not available)



_TH -RA

Note:

Some lengths, styles and options are non-standard, non-returnable.